

# SN54ABT16952, SN74ABT16952 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS082C – FEBRUARY 1991 – REVISED JANUARY 1997

- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs ( $-32\text{-mA } I_{OH}$ ,  $64\text{-mA } I_{OL}$ )
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

## description

The 'ABT16952 are 16-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. The 'ABT16952 can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is stored in the registers on the low-to-high transition of the clock (CLKAB or CLKBA) input provided that the clock-enable (CLKENAB or CLKENBA) input is low. Taking the output-enable ( $\overline{OEAB}$  or  $\overline{OEBA}$ ) input low accesses the data on either port.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16952 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT16952 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

## SN54ABT16952 . . . WD PACKAGE SN74ABT16952 . . . DGG OR DL PACKAGE (TOP VIEW)

$\overline{1OEAB}$	1	56	$\overline{1OEBA}$
$\overline{1CLKAB}$	2	55	$\overline{1CLKBA}$
$\overline{1CLKENAB}$	3	54	$\overline{1CLKENBA}$
GND	4	53	GND
1A1	5	52	1B1
1A2	6	51	1B2
$V_{CC}$	7	50	$V_{CC}$
1A3	8	49	1B3
1A4	9	48	1B4
1A5	10	47	1B5
GND	11	46	GND
1A6	12	45	1B6
1A7	13	44	1B7
1A8	14	43	1B8
2A1	15	42	2B1
2A2	16	41	2B2
2A3	17	40	2B3
GND	18	39	GND
2A4	19	38	2B4
2A5	20	37	2B5
2A6	21	36	2B6
$V_{CC}$	22	35	$V_{CC}$
2A7	23	34	2B7
2A8	24	33	2B8
GND	25	32	GND
$\overline{2CLKENAB}$	26	31	$\overline{2CLKENBA}$
$\overline{2CLKAB}$	27	30	$\overline{2CLKBA}$
$\overline{2OEAB}$	28	29	$\overline{2OEBA}$



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# SN54ABT16952, SN74ABT16952

## 16-BIT REGISTERED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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FUNCTION TABLE†

INPUTS				OUTPUT B
$\overline{\text{CLKENAB}}$	$\text{CLKAB}$	$\overline{\text{OEAB}}$	A	
H	X	L	X	$B_0^{\ddagger}$
X	L	L	X	$B_0^{\ddagger}$
L	$\uparrow$	L	L	L
L	$\uparrow$	L	H	H
X	X	H	X	Z

† A-to-B data flow is shown; B-to-A data flow is similar, but uses  $\overline{\text{CLKENBA}}$ ,  $\text{CLKBA}$ , and  $\overline{\text{OEBA}}$ .

‡ Level of B before the indicated steady-state input conditions were established

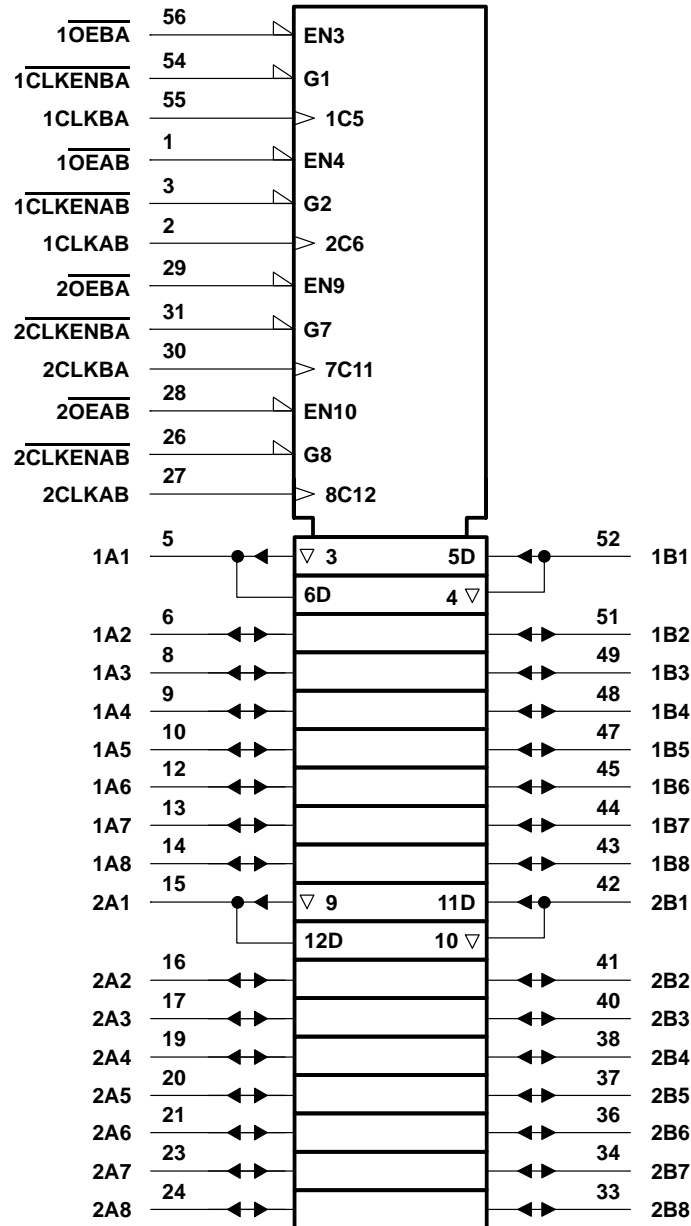


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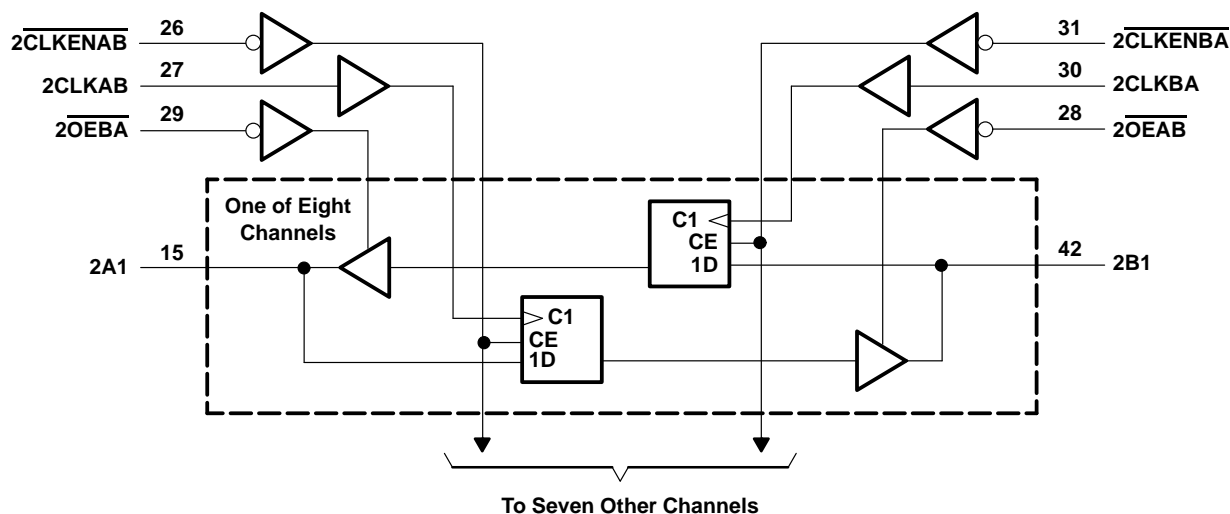
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16952	96 mA
SN74ABT16952	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

## recommended operating conditions (see Note 3)

		SN54ABT16952		SN74ABT16952		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		–24		–32	mA
$I_{OL}$	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10	ns/V
$T_A$	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

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## 16-BIT REGISTERED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T <sub>A</sub> = 25°C			SN54ABT16952		SN74ABT16952		UNIT
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA		-1.2			-1.2		-1.2		V
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA		2.5			2.5		2.5		V
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA		3			3		3		
		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -24 mA	2			2				
			I <sub>OH</sub> = -32 mA	2*					2		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA	0.55			0.55				V
			I <sub>OL</sub> = 64 mA	0.55*					0.55		
V <sub>hys</sub>				100							mV
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±1			±1		±1		μA
	A or B ports			±100			±100		±100		
I <sub>OZH</sub> ‡		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.7 V		50			50		50		μA
I <sub>OZL</sub> ‡		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0.5 V		-50			-50		-50		μA
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V		±100					±100		μA
I <sub>CEX</sub>		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high	50			50		50		μA
I <sub>O</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V		-50	-100	-200	-50	-200	-50	-200	mA
I <sub>CC</sub>	A or B ports	V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high	2			2		2		mA
			Outputs low	35			35		35		
			Outputs disabled	2			2		2		
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND		0.5			0.5		0.5		mA
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V		3							pF
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V		8.5							pF

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

			$V_{CC} = 5\text{ V},$ $T_A = 25^\circ\text{C}$		SN54ABT16952		SN74ABT16952		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
$f_{\text{clock}}$	Clock frequency		0	150	0	150	0	150	MHz
$t_w^\dagger$	Pulse duration, CLKAB or CLKBA high or low		3.3		3.3		3.3		ns
$t_{\text{su}}$	Setup time, before CLKAB $\uparrow$ or CLKBA $\uparrow$	A or B	3.5		3.5		3.5		ns
		CLKENAB or CLKENBA	3		3		3		
$t_h$	Hold time, after CLKAB $\uparrow$ or CLKBA $\uparrow$	A or B	1		1		1		ns
		CLKENAB or CLKENBA	1		1		1		

$^\dagger$  This parameter is warranted, but not production tested.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5\text{ V},$ $T_A = 25^\circ\text{C}$			SN54ABT16952		SN74ABT16952		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\text{max}}$			150			150		150		MHz
$t_{\text{PLH}}$	CLK	A or B	1	2.6	3.9	1	4.4	1	4.3	ns
$t_{\text{PHL}}$			1	2.6	4.2	1	4.6	1	4.5	
$t_{\text{PZH}}$	$\overline{\text{OE}}$	A or B	1	2.5	3.8	1	4.7	1	4.6	ns
$t_{\text{PZL}}$			1	2.8	5.1	1	6.1	1	6	
$t_{\text{PHZ}}$	$\overline{\text{OE}}$	A or B	1.7	3.4	4.7	1.7	6.1	1.7	5.5	ns
$t_{\text{PLZ}}$			1.3	3	3.9	1.3	4.8	1.3	4.2	

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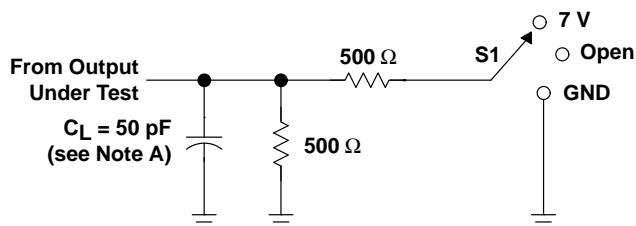


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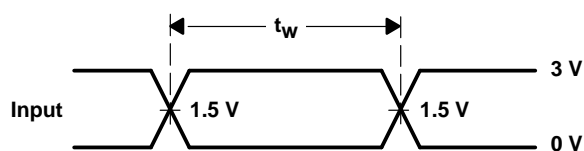
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## PARAMETER MEASUREMENT INFORMATION

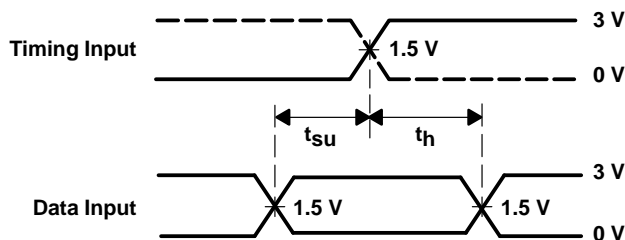


LOAD CIRCUIT

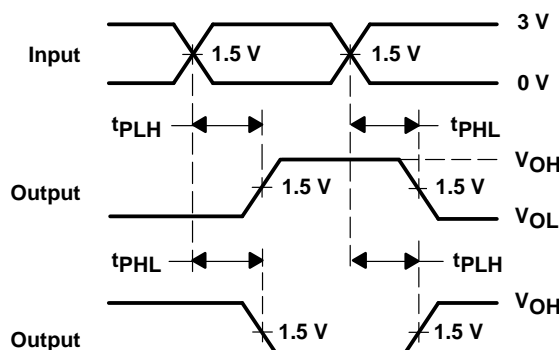
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



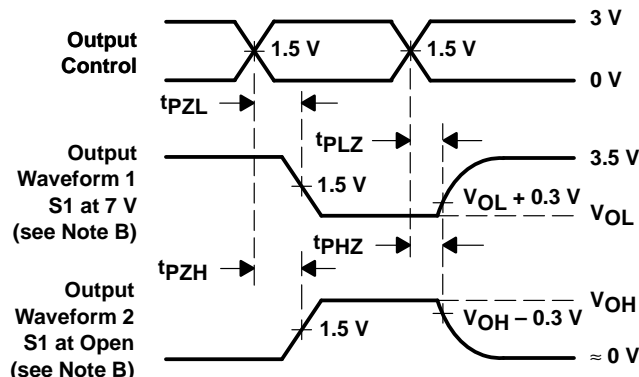
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .  
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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